



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Akram et al.

Serial No.: 10/055,298

Filed: January 23, 2002

For: METHOD AND APPARATUS FOR  
CONDUCTING HEAT IN A FLIP-CHIP  
ASSEMBLY

Examiner: Unknown

Group Art Unit: Unknown

Attorney Docket No.: 4376.1US (99-0660.1)

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PRELIMINARY AMENDMENT

Box Non-Fee Amendment  
Commissioner for Patents  
Washington, D.C. 20231

Sir:

Prior to examination of the above-referenced patent application on the merits, entry of the amendments as set forth herein is respectfully solicited.

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